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DOBE Sys, Inc

1	Page 3 of 7	(2007/11/1) Ver 1.0 Engineering/Bill of Material LIST	Material LI	ST	-	<u>-</u>	Model: DHS1000
1		Description	Package	Vender	Qty	Unit	Location Number
2 2 2 2 2 3 3 4 4 3 3 4 5 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6 6		PACKING ASSY					
	.2	USER MANUAL			-	EA	
	7	BOX,100X150X200			1	EA	
	2	WIRE-HARNESS ASSY, Basic Cable(USB, Keyboard) BOX		All Tech Korea	-	EA	
	5.	POLY BAG,			-	ΕA	
	.2	SET ASSY					
L	£.	LABEL, Serial Number			_	EA	
	ن	LABEL, EMI.CE.FCC. Name			1	EA	
E E E E E E E E E E E E E E E E E E E	3	MOLD, TOP Cover(Polycarbonate)		All Tech Korea	-	EA	
	3	LENS, Indication LED(Polycarbonate)		All Tech Korea	-	EA	
E	٤:	MOLD, Head Rubber (Urethane Rubber)		All Tech Korea	-	EA	
	.3	MOLD, Window Rubber(Polycarbonate + Urethane rubber)		All Tech Korea	-	EA	
Ei Ei Ei Ei Ei Ei	.3	MOLD, Window (Polycarbonate)		All Tech Korea	-	EA	
£1 £1 £1 £1 £1	٤.	MOLD, Handle Cover (Polycarbonate + Urethane rubber)		All Tech Korea	-	EA	
1, 1, 1, 1, 1, 1	٤.	MOLD, END CAP (Urethane Rubber)		All Tech Korea	1	EA	
£ £ £	٤.	MOLD, KNOB (Polycarbonate)		All Tech Korea	1	EA	
ti ti (	£.	MOLD, KNOB Holder (Polycarbonate)		All Tech Korea	-	EA	
£.,	٤.	SCREW, #2 BT 2.6X10			3	EA	
•	£.	SCREW, #2 BT 2.6X4			4	EA	
	3	SCREW, #2 FT 2.6X6			2	EA	

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8	Level	Description	Package	Vender	Oty	Unit	Location Number
21	6.	PWBA, 1D Hand Scanner DH1010 SENSOR BOARD ASSY					
22	4	CCD,TCD1304DG (CCD Linear Image Sensor)	22Pin CERDIP	TOSHIBA	1	EA	U11
23	4	SOCKET, 2.54mm Machined Pin Pitch:10.16mm	22PIN DIP	Hsuan Mao	1	EA	U11
24	4	Wire-Harness Assy, CCD Cable (SD51022-0700 互替)1.25X7		All Tech Korea	1	EA	CNS
25	4	PCB, 1D Hand Scanner DH1010 SENSOR PCB			1	EA	
56	4	1D Optics Lens Module (Lens, LED, CASE, SCREW)		DYT	1	SET	
27	3	PWBA, 1D Hand Scanner DH1010 MAIN BOARD ASSY					
28	44	IC, AT91SAM7S64	LQFP64	ATMEL	-	EA	UI
29	4	IC,EM78P156ELM (8bit Micro-Controller)	SOP18	EMC	-	EA	U2
30	4	IC, ADC1173CIMTC	TSSOP24	National	-	EA	U3
31	4	IC, SN74LVC14PW	TSSOP14	TI, PHILIPS	_	EA	U6
32	4	IC, AT24C32AN-10SU-2.7	SOIC8	ATMEL	-	EA	U7.
33	4	IC, LMV358M	SOIC8	National	2	EA	U8.U12
34	4	X-TAL, 18.432MHz	SMD ATS-SX3	SUNNY	-	EA	XI
35	44	X-TAL, 20.000MHz	SMD ATS-SX3	SUNNY	-	EA	X2
36	4	CHIP Capacitor, C-T 10pF/50V	0603 SIZE		2	EA	C2,C3
37	4	CHIP Capacitor, C-T 15pF/50V	0603 SIZE		6	EA	C4,C5,C16
38	4	CHIP Capacitor, C-T 47pF/50V	0603 SIZE		-	EA	CI
39	*	CHIP Capacitor, C-T 100pF/50V	0603 SIZE		-	EA	C12
9	4::	CHIP Capacitor, C-T 1nF/50V	0603 SIZE		2	EA	C10,C33

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NO	Level	Description	Package	Vender	Oty	Unit	Location Number
41	4	CHIP Capacitor, C-T 10nF/50V	0603 SIZE		1	EA	C11
42	4	CHIP Capacitor, C-T 0.1uF/50V	0603 SIZE		20	EA	C9,C14,C15,C34~C43,
							C47~C49,C52~C55
43	4	CHIP Capacitor, T-T 10uF/16V	B SIZE		7	EA	C58~C60,C63~C65,C67
44	4	CHIP RESISTOR, 22	0603 SIZE		=	EA	R3~R11,R40,R46
45	4	CHIP RESISTOR, 47	0603 SIZE		7	EA	R44,R45
46	4	CHIP RESISTOR, 100	0603 SIZE		1	EA	R38
47	4.:	CHIP RESISTOR, 330	0603 SIZE		-	EA	R39
48	4	CHIP RESISTOR, 470	0603 SIZE		_	EA	R48
49	4	CHIP RESISTOR, 1K	0603 SIZE		4	EA	R32,R35~R37
50	4	CHIP RESISTOR, 1.5K	0603 SIZE		2	EA	R13,R14
51	4.:	CHIP RESISTOR, 4,7K	0603 SIZE		2	EA	R29,VR4
25	4	CHIP RESISTOR, 10K	0603 SIZE		21	EA	R15~R19,R21~R28,R34,R50~
							R54,VR3,VR5
53	4	CHIP RESISTOR, 20K	0603 SIZE		2	EA	R12,R42
45	4	CHIP RESISTOR, 33K	0603 SIZE		-	EA	VR2
55	4	CHIP RESISTOR, 51K	0603 SIZE		-	EA	VRI
99	4:	CHIP RESISTOR, 100K	0603 SIZE		-	EA	R33
57	4:	CHIP RESISTOR, 200K	0603 SIZE		2	EA	R41,R43
28	4.:.	CHIP RESISTOR NETWORK, 8PIN 10K	0603 SIZE		7	ΕA	RN2-RN3
59	4:	CHIP DIODE, LL4148	MiniMELF	DIODES	_	EA	D2



NO Level 604 614	el Description	Dockogo	Vender	(		
		r achage	1 111111	Çţ	Chit	Location Number
	CHIP TR,MMBT3904(NPN)	SOT-23	FAIRCHILD	4	EA	02~05
	FET, IRLML6401	SOT-23	IOR	-1	EA	FET1
624	CHIP FERRITE BEAD, HH-1H3216-500JT	A SIZE	CERATECH	4	EA	FB1,FB9~FB11
634	SWUTC, TACT SWITCH SKRAAQE010	SMD	ALPS	1	EA	SW1
644	LED, RF-OUS15-TS-CE RED	SMD 3516	REFOND	1	EA	LED3
654	LED, RF-GUS150TS-CF GRREN	SMD 3516	REFOND	1	EA	LED4
664	CONNECTOR, SD-53398-0719 1.25mm S/T Type	SMT	Molex	1	EA	CN2
674	CONNECTOR, FPC/FFC 0.5mm 05005HS-18F 18PIN	SMT	YEONHO	1	EA	CN3
684	PCB, 1D Hand Scanner DH1010 MAIN PCB			1	EA	
693	PWBA, 1D Hand Scanner DH1010 HANDLE BOARD ASSY					
704	IC, LM1117MPX-3.3	SOT-223	National,	1	EA	U4
714	IC, 74HC4066PW	TSSOP14	PHILIPS,	-	EA	US
7.2	CHIP Capacitor, C-T 15pF/50V	0603 SIZE		2	EA	C6,C7
734	CHIP Capacitor, C-T 33pF/50V	0603 SIZE		_	EA	. 83
744	CHIP Capacitor, C-T 47pF/50V	0603 SIZE		4	EA	C26-C29
754	CHIP Capacitor, C-T 0.1uF/50V	0603 SIZE		S	EA	C13,C45,C46,C50,C51
764	CHIP Capacitor, T-T 10uF/16V	B SIZE		2	EA	C61~C62
774	SURFACE MOUNT A/E CAPACITORS, 100uF/16V MV	F60 SMD	SAMYOUNG	2	EA	C56,C57
784	CHIP RESISTOR, 22	0603 SIZE		2	EA	R1,R2
794	CHIP RESISTOR, 1K	0603 SIZE		7	EA	R30,R31

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NO	Level	Description	Package	Vender	Qty	Unit	Location Number
80		CHIP RESISTOR, 10K	0603 SIZE	:	S	EA	R20,R55~R58
81	4	CHIP DIODE, LL 4148	MiniMELF	DIODES	1	EA	01
82	4	CHIP DIODE, BAV99	SOT-23	DIODES	4	EA	D3~,D6
83	4.:	CHIP TR,MMBT3904(NPN)	SOT-23	FAIRCHILD	-	EA	01
84	4	CHIP FERRITE BEAD, HH-1H3216-500JT	A SIZE	CERATECH	7	EA	FB2~FB8
85	4	BELL, MAGNRTIC TRANSDUCER 1205X			-	EA	SP1
98	4	JACK, MODULAR JACK RJ45 10P-10C R/A N3901-S10-001	DIP 10PIN	HANHONG	-	EA	CN1
87	4	CONNECTOR, FPC/FFC 0.5mm 05003HR-18A01 18PIN	SMT	YEONHO	-	EA	CN4
88	4	FPC/FFC JUMPER, 0.5mm (Type B-T), 18PIN 80mm		MOLEX	1	EA	
<b>6</b> 8	4	PCB, 1D Hand Scanner DH1010 HANDLE PCB			-	EA	
06							
16							
92							
93							
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96							
97							
86		- And Andrews					
66							

